Next monday, Ang. 30th.

Everyphils 3D Shudow.
Protessing 1 (0%)
Engine Engine | 6 Pill --ED Gruphils =3075,30%. Angust 25 (wed) 10% Teflection midterm: 30%, Final 40% (Comprehensive) Today's Topics: 1°Bill of material Option 1. (5%+) NUDA NAND Reference: zithub/hudili /Cmpez40/2018F Ja. Likely Devices Ordrers, O.S. C/C++, Pythow. b. I/D Juterface. Edge AI "The B.

GPID, SPI. The B. D.M. 1. CPM module NXP LPCITG Optim 7. (5%+) RISC-V Target 3rd Party (Digital Aut), module To Distributors Sol, FPGA Board, Proposit (me parmyruph), Submission Digiton. Lom, Monser. Com etc. Expecting Delans. Lead Time Over & Weeks By Sept 157 (Wed) vin 5-mml Alternative 1 Te-we the proviously Policy ON Project Submission 1º. Form 3-4 Person Team. Team (4 Person) Zo No Sourie Code Design material Each person will neal to have Course Copied: All Course material has to be completed judicidnally; his her Board; Option 1: NAND. a 4400+ "firmware" Datasheet 3° Lateroject, 10% perweek; b Jetpack 4,3 or Higher tool for o (O.S.+Libs.+Puckages) Flashing the CPU modele

SLEDS. (Red Green) for PWIZ. ⊆ Coding in Both user & Kernel Spares. → O.S. Distr. Tool Chain, Device Oniver Debugging (GPID), ILEO=4~10mA donnertors.

di Ji for POWR Input Rpin & Davelopment; Option Z. PCISC-V. verilog, FPGA. Jo mont CPU module. 2. Fower Regulator IC Suchis 78/2,7805/... 1117 78xx

78xx

Vin Vont

Fig. 1.

5.0 VOC "12", 12VVC & Switch, S/WI: to togale FWR

SINZ

Wive for

Wive Wrapping Soldering

28-30 AWG Vin 7 Voit + 1.5 Voc (1)

DC. Voltage Source Admitor

Admitor

Admitor

To Vin

To Vin

Of 7805 4. Color LCD Display module SPI (Seial Peripheral

Interfence)

E Software Graphic Oniver

Clott Lib. (Driver)

Actual Interfence LCD. g.voc (a) formwtswmw] Chirent Feeding.
Why Do
Ne use it?
Rating MC U Xphesso (ID.E.) 5. "Other" thing. Deplay the System. 75J-45 Connector 3. "Glue" Componments Cops 47MF 12 Tright Angle